## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

| SUBMISSION TYPE:      | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT     |

### **CONVEYING PARTY DATA**

| Name         | Execution Date |
|--------------|----------------|
| Kenji TANAKA | 09/11/2007     |

### **RECEIVING PARTY DATA**

| Name:           | Elpida Memory, Inc.         |  |
|-----------------|-----------------------------|--|
| Street Address: | 2-1, Yaesu 2-chome, Chuo-ku |  |
| City:           | Tokyo                       |  |
| State/Country:  | JAPAN                       |  |

### PROPERTY NUMBERS Total: 1

| Property Type       | Number   |
|---------------------|----------|
| Application Number: | 11860579 |

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 8040-1098

NAME OF SUBMITTER: Benoit Castel

Total Attachments: 1 source=ASSIGN#page1.tif

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PATENT REEL: 019870 FRAME: 0929

**RECORDED: 09/25/2007** 

# ASSIGNMENT

| WHEREAS, I, Kenji TANAKA of Tokyo, Japan  |
|---|
| have invented certain new and useful improvements in  |
| MANUFACTURING METHOD OF SEMICONDUCTOR DEVICE  |
| for which I have made application for Letters   |
| Patent of the United States of America;   |
| AND WHEREAS,  |
| Elpida Memory, Inc., 2-1, Yaesu 2-chome, Chuo-ku, Tokyo, Japan  |
| is desirous of acquiring an interest therein and in the Letters Patent to be obtained therefor from the       |
| United States;  |
| NOW, THEREFORE, be it known by all whom it may concern, that for and in consideration of                      |
| One Dollars (\$ 1.00 )  |
| to <u>me</u> in hand paid, the receipt of which is hereby acknowledgeI  |
| have assigned, sold, and set over, and by these presents do hereby assign, sell, and set over unto the said   |
| ASSIGNEE, Elpida Memory, Inc.   |
| the full and exclusive right, title, and interest in and to the said invention,                               |
| as fully set forth and described in the:  |
| (a) specification prepared and executed by <u>me</u> on the <u>11th</u> day of <u>September</u> , <u>2007</u> |
| (b) application filed on the day of, Serial no  |
| preparatory to obtaining Letters Patent therefor; said invention, application and Letters Patent to be        |
| held and enjoyed by the said ASSIGNEE, Elpida Memory, Inc.  |
| for their own use and behoof, and for their legal representatives, to the full end of the term                |
| for which said Letters Patent are granted, as fully and entirely as the same would have been held by          |
| me had this assignment and sale not been made.  |
| IN TESTIMONY WHEREOF, hereunto set our hand and affix _myseal at  |
| Tokyo, Japan this 11th day of September , A.D. 2007   |
|   |
|   |
| Kenji Tomaker   |
| Kenji TANAKA  |
| Witness:  |
| Taken Tajin (\$\frac{1}{2})   |
| Taken FWII  |

PATENT REEL: 019870 FRAME: 0930